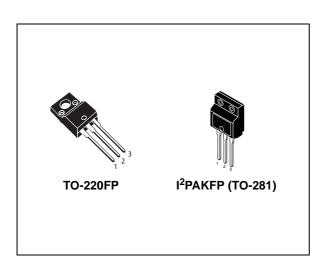


# STF9N60M2, STFI9N60M2

Datasheet - production data

## N-channel 600 V, 0.72 Ω typ., 5.5 A MDmesh II Plus™ low Q<sub>g</sub> Power MOSFETs in TO-220FP and I<sup>2</sup>PAKFP packages



# Figure 1. Internal schematic diagram

#### Features

Order codes	V <sub>DS</sub> @ T <sub>Jmax</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STF9N60M2	650 V	0.78 Ω	5.5 A
STFI9N60M2	000 V	0.70 32	0.0 A

- Extremely low gate charge
- Lower R<sub>DS(on)</sub> x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

## Applications

Switching applications

## Description

These devices are N-channel Power MOSFETs developed using a new generation of MDmesh<sup>TM</sup> technology: MDmesh II Plus<sup>TM</sup> low Q<sub>g</sub>. These revolutionary Power MOSFETs associate a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. They are therefore suitable for the most demanding high efficiency converters.

#### Table 1. Device summary

Order codes	Marking	Package	Packaging
STF9N60M2	9N60M2	TO-220FP	Tube
STFI9N60M2	JINOUMZ	I <sup>2</sup> PAKFP	Tube

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This is information on a product in full production.

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#### 1

# Electrical ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	± 25	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	5.5 <sup>(1)</sup>	А
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	3.6 <sup>(1)</sup>	А
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	22 <sup>(1)</sup>	А
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \text{ °C}$	20	W
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; $T_C$ =25 °C)	2500	V
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/115
T <sub>stg</sub>	Storage temperature	- 55 to 150	ംറ
Тj	Max. operating junction temperature	150	

#### Table 2. Absolute maximum ratings

1. Pulse width limited by safe operating area.

2.  $~I_{SD}~{\leq}5.5$  A, di/dt  $~{\leq}400$  A/µs; V\_{DS peak} < V\_{(BR)DSS}, V\_DD=400 V

3.  $V_{DS} \leq 480 \text{ V}$ 

#### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	6.25	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient max	62.5	°C/W

#### Table 4. Avalanche characteristics

Symbol	Symbol Parameter		Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	2	A
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j=25^{\circ}C$ , $I_D=I_{AR}$ ; $V_{DD}=50$ )	105	mJ



## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	600			V
	Zero gate voltage	V <sub>DS</sub> = 600 V			1	μΑ
I <sub>DSS</sub>	drain current ( $V_{GS} = 0$ )	V <sub>DS</sub> = 600 V, T <sub>C</sub> =125 °C			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	$V_{CC} = +25 V$			±10	μA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3 A		0.72	0.78	Ω

#### Table 5. On /off states

#### Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	320	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz,	-	18	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$	-	0.68	-	pF
C <sub>oss eq.</sub> <sup>(1)</sup>	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$	-	88	-	pF
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	6.5	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 5.5 A,	-	10	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	2	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 15)	-	5.1	-	nC

1. Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	8.8	-	ns
t <sub>r</sub>	Rise time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 3 A, R <sub>G</sub> = 4.7 Ω, V <sub>GS</sub> = 10 V	-	7.5	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 14 and Figure 19)	-	22	-	ns
t <sub>f</sub>	Fall time		-	13.5	-	ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		5.5	А
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		22	А
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 5.5 A, V <sub>GS</sub> = 0	-		1.6	V
t <sub>rr</sub>	Reverse recovery time		-	265		ns
Q <sub>rr</sub>	Reverse recovery charge	$I_{SD} = 5.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V} (\text{see Figure 16})$	-	1.65		μC
I <sub>RRM</sub>	Reverse recovery current		-	12.5		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 5.5 A, di/dt = 100 A/µs	-	377		ns
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$	-	2.3		μC
I <sub>RRM</sub>	Reverse recovery current	(see Figure 16)	-	12.2		А

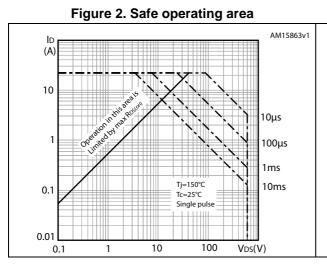
Table 8. Source drain diode

1. Pulse width limited by safe operating area.

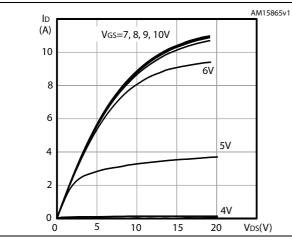
2. Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%



## 2.1 Electrical characteristics (curves)



#### Figure 4. Output characteristics





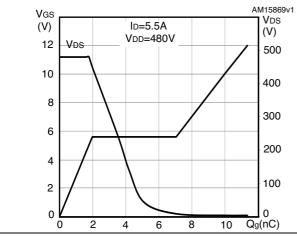


Figure 3. Thermal impedance

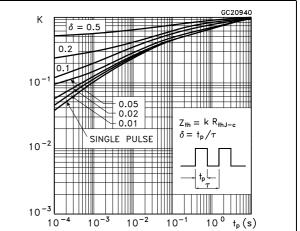
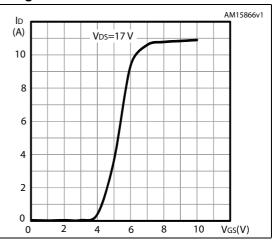
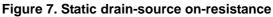
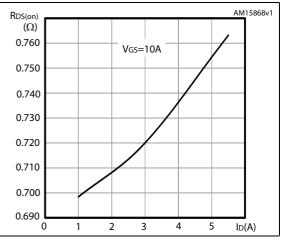


Figure 5. Transfer characteristics









0.1

0.1

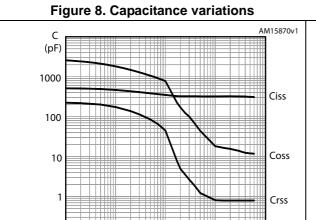


Figure 10. Normalized gate threshold voltage vs temperature

1

10

VDS(V)

100

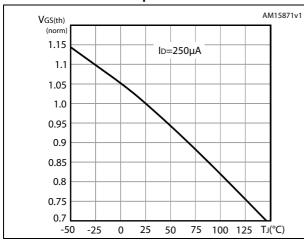


Figure 12. Source-drain diode forward characteristics

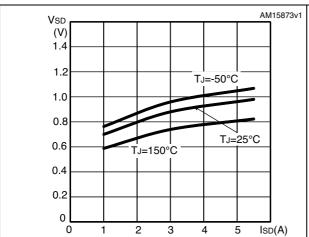
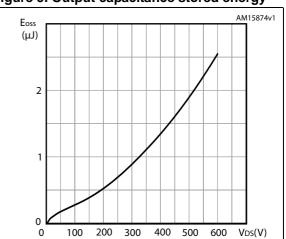
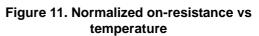


Figure 9. Output capacitance stored energy





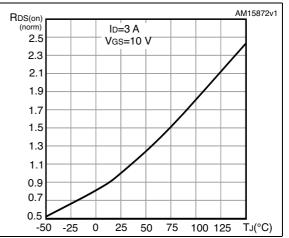
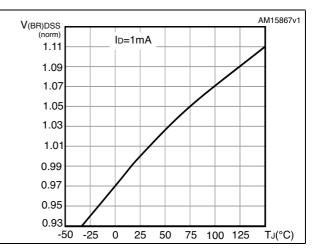


Figure 13. Normalized V<sub>(BR)DSS</sub> vs temperature





#### 3 **Test circuits**

Figure 14. Switching times test circuit for resistive load

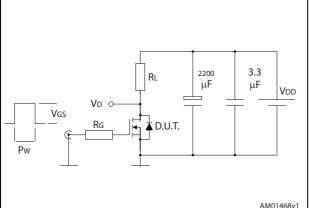


Figure 16. Test circuit for inductive load switching and diode recovery times

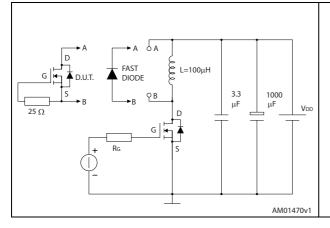
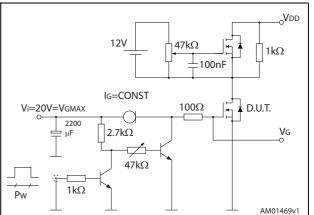


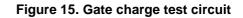
Figure 18. Unclamped inductive waveform

VD

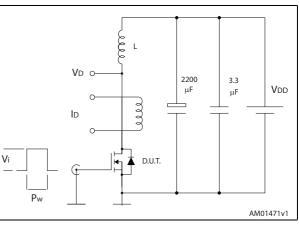
ldм

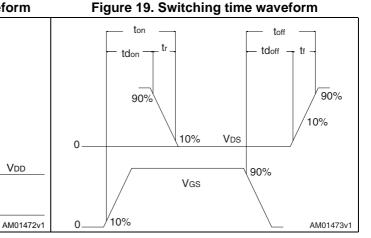
ID











Vdd

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V(BR)DSS



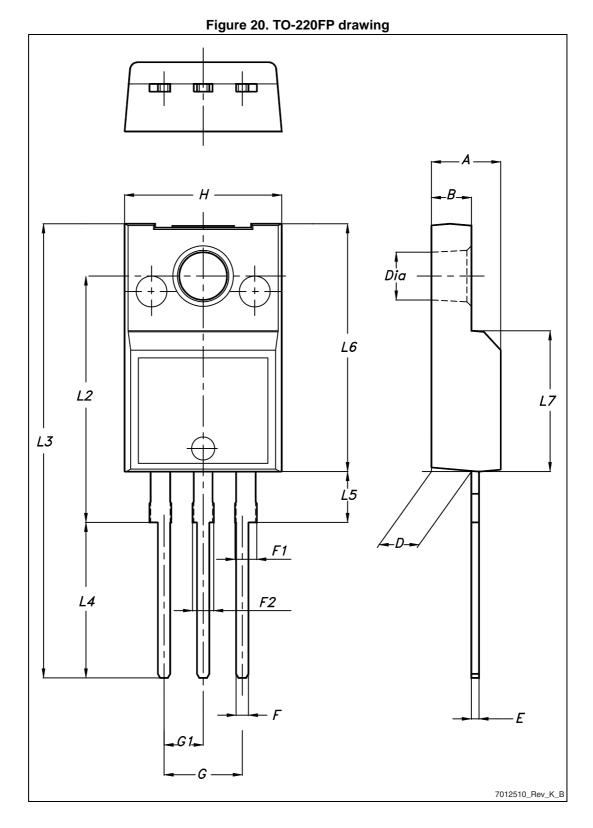
Vdd

# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



## 4.1 TO-220FP, STF9N60M2



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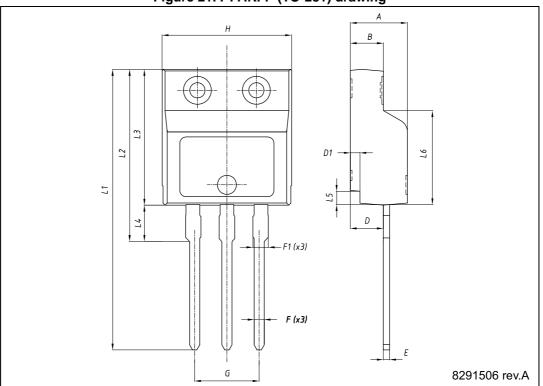


		mm	
Dim. —	Min.	Тур.	Max.
A	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Table 9. TO-220FP mechanical data



## 4.2 I<sup>2</sup>PAKFP (TO-281), STFI9N60M2



#### Figure 21. I<sup>2</sup>PAKFP (TO-281) drawing



Table 10. I-PAKFP (10-281) mechanical data				
Dim.	mm			
	Min.	Тур.	Max.	
А	4.40		4.60	
В	2.50		2.70	
D	2.50		2.75	
D1	0.65		0.85	
Е	0.45		0.70	
F	0.75		1.00	
F1			1.20	
G	4.95	-	5.20	
Н	10.00		10.40	
L1	21.00		23.00	
L2	13.20		14.10	
L3	10.55		10.85	
L4	2.70		3.20	
L5	0.85		1.25	
L6	7.30		7.50	

Table 10. I<sup>2</sup>PAKFP (TO-281) mechanical data



# 5 Revision history

Date	Revision	Changes	
03-Jun-2013	1	First release. The part number was previously included in datasheet DocID024399.	
10-Mar-2014	2	Added: I <sup>2</sup> PAKFP package Minor text changes	

#### Table 11. Document revision history



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